

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

TRODUCT	INOCESS	CHANGE NOTICE (I CN)		
PCN #: TB1711-01 Product Affected: F0502NLGI, F0502N	DATE: 10-Nov-2 0 NLGI8	MEANS OF DISTINGUISHING CHANGED DEVICES: □ Product Mark □ Back Mark □ Date Code maintained by IDT and available on request		
Date Effective: 10-Feb-2018				
Contact: IDT PCN DESK E-mail: pcndesk@idt.com		Attachment: Yes No Samples: Please contact your local sales representative for sample request.		
DESCRIPTION AND PURPOSE OF CH	IANGE:			
 □ Die Technology □ Wafer Fabrication Process □ Assembly Process □ Equipment □ Material □ Testing ■ Manufacturing Site □ Data Sheet □ Other 	(USG) as an altern	to advise our customers that IDT is adding UTAC, Singapore ate facility for Test process for the selective products that are IDT Penang, Malaysia facility. Is the change.		
RELIABILITY/QUALIFICATION SUMMARY:				
There is no expected change to the product quality or reliability performance. Please refer to Attachment I for Electrical correlation data.				
CUSTOMER ACKNOWLEDGMENT OF RECEIPT: IDT records indicate that you require written notification of this change. Please use the acknowledgement below or E-Mail to grant approval or request additional information. If IDT does not receive acknowledgement within 30 days of this notice it will be assumed that this change is acceptable. IDT reserves the right to ship either version manufactured after the process change effective date until the inventory on the earlier version has been depleted.				
Customer:		☐ Approval for shipments prior to effective date.		
Name/Date:		E-Mail Address:		
Title:		Phone# /Fax# :		
CUSTOMER COMMENTS:				
IDT ACKNOWLEDGMENT OF RECE	IPT:			
RECD. BY:		DATE:		

Integrated Device Technology, Inc. 6024 Silver Creek Valley Road, San Jose, CA - 95138

PRODUCT/PROCESS CHANGE NOTICE (PCN)

ATTACHMENT I - PCN # : TB1711-01

PCN Type: Manufacturing Site - Alternate Test Location

Data Sheet Change: None

Detail Of Change:

This notification is to advise our customers that IDT is adding UTAC, Singapore (USG) as an alternate facility for Test process for the selective products that are presently tested at IDT Penang, Malaysia facility.

This change will allow IDT the flexibility to ship from either facility and will provide the increased capacity, flexibility and shorter lead time to meet market demand.

There is no change in the Test processing flows. Load boards and test programs are the same at both qualified facilities. IDT has completed the electrical test correlation and based on the test results we do not anticipate any impact on device performance. The testing is fully compatible and transferrable between the test facilities with no change to the test coverage.

There is no change in the moisture sensitivity level (MSL).

If you require samples to conduct evaluations, please contact your local sales representative to acknowledge this PCN and request samples.

PRODUCT/PROCESS CHANGE NOTICE (PCN)

ATTACHMENT I - PCN #: TB1711-01

Qualification Information and Qualification Data: Electrical Test Correlation Results

Vehicle: F0502NLGI

Sample size: 544 electrically good units tested by handler &

10 good and 10 reject units tested by hand test

Description	Existing Test (IDT - IDT, Penang)	Alternate Test (USG - UTAC, Singapore)
Tester Platform	LTX	LTX
Loadboard	ME113A	ME113A
Test Program	IDTF0502NBGI_CB_SEQ0900	IDTF0502NBGI_CB_SEQ0900
Test Site	Single Site	Single Site
Test Temperature	Ambient	Ambient
Test Correlation Results	100%	100%
Number of Good Units Correlated (Handler)	544 pcs	544 pcs
544 units Bin 1 run	Passed	Passed
544 units Bin 1 datalog correlation	Passed	Passed
Number of Good Units (Hand Tested)	10 pcs	10 pcs
10 good units datalog correlation	Passed	Passed
Number of Reject Units (Hand Tested)	10 pcs	10 pcs
10 reject units datalog correlation	Passed	Passed